

### 4A HIGH VOLTAGE SCHOTTKY BARRIER RECTIFIER PowerDI®5

#### **Features**

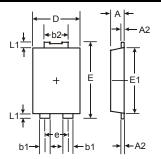
- Guard Ring Die Construction for Transient Protection
- Low Forward Voltage Drop
- · Very Low Leakage Current
- High Maximum Junction Temperature Capability
- Highly Stable Oxide Passivated Junction
- High Forward Surge Current Capability
- Lead Free Finish, RoHS Compliant (Note 1)
- "Green" Molding Compound (No Br, Sb)
- Qualified to AEC-Q101 Standards for High Reliability

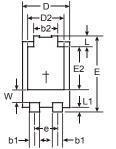
# Mechanical Data

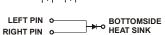
Case: PowerDI<sup>®</sup>5

 Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0

- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 (§3)
- Polarity: See Diagram
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.096 grams (approximate)







Note: Pins Left & Right must be electrically connected at the printed circuit board.

PowerDI <sup>®</sup> 5			
Dim	Min	Max	
Α	1.05	1.15	
A2	0.33	0.43	
b1	0.80	0.99	
b2	1.70 1.88		
D	3.90 4.05		
D2	3.05 NOM		
Е	6.40	6.60	
е	1.84 NOM		
E1	5.30 5.45		
E2	3.55 NOM		
L	0.75	0.95	
L1	0.50	0.65	
W	1.20 1.50		
All Dimensions in mm			

## Maximum Ratings @TA = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	150	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	106	V
Average Rectified Output Current (See also figure 4)	Io	4	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load	I <sub>FSM</sub>	180	Α

### **Thermal Characteristics**

Characteristic	Symbol	Тур	Max	Unit
Thermal Resistance Junction to Soldering Point	$R_{ heta JS}$		2.0	°C/W
Thermal Resistance Junction to Ambient Air (Note 2) T <sub>A</sub> = 25°C	$R_{\theta JA}$	90	_	°C/W
Thermal Resistance Junction to Ambient Air (Note 3) T <sub>A =</sub> 25°C	$R_{\theta JA}$	60	_	°C/W
Thermal Resistance Junction to Ambient Air (Note 4) T <sub>A</sub> = 25°C	$R_{ heta JA}$	40	_	°C/W
Operating and Storage Temperature Range	T <sub>j</sub> , T <sub>STG</sub>	-65 to	+175	°C

Notes:

- 1. RoHS revision 13.2.2003. High temperature solder exemption applied, see *EU Directive Annex Note* 7.
- 2. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/datasheets/ap02001.pdf.
- 3. Polyimide PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/datasheets/ap02001.pdf. 4. Polyimide PCB, 2 oz. Copper. Cathode pad dimensions 9.4mm x 7.2mm. Anode pad dimensions 2.7mm x 1.6mm.

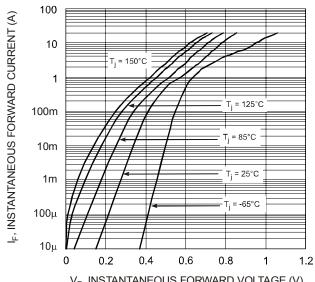
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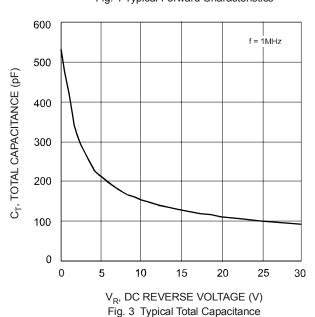
## **Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

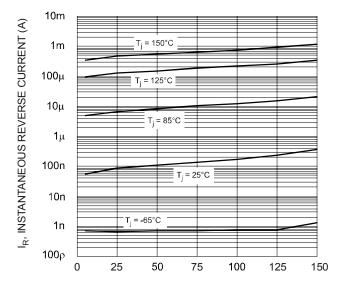
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)	V <sub>(BR)R</sub>	150	_	_	V	$I_R = 10 \mu A$
		_	0.71	0.76	V	I <sub>F</sub> = 4A, T <sub>S</sub> = 25°C
Forward Voltage	V <sub>F</sub>	_	0.57	0.64		I <sub>F</sub> = 4A, T <sub>S</sub> = 125°C
1 orward voitage	VF	_	0.77	0.81		$I_F = 8A, T_S = 25^{\circ}C$
		_	0.63	0.70		I <sub>F</sub> = 8A, T <sub>S</sub> = 125°C
Reverse Leakage Current (Note 5)	lo.	_	0.3	10	μΑ	$T_S = 25^{\circ}C, V_R = 150V$
Neverse Leakage Guiterii (Note 3)	IR	_	0.4	4.5	mA	$T_S = 125^{\circ}C, V_R = 150V$

Notes: 5. Short duration pulse test used to minimize self-heating effect.

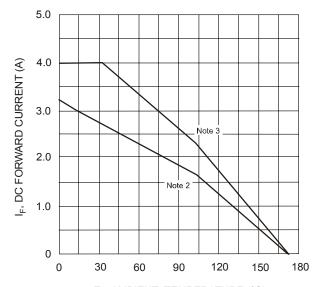


V<sub>F</sub>, INSTANTANEOUS FORWARD VOLTAGE (V) Fig. 1 Typical Forward Characteristics



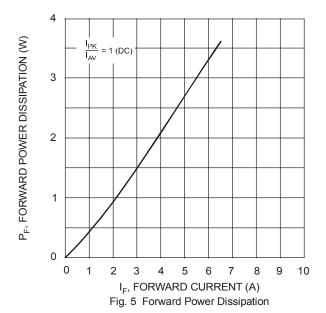


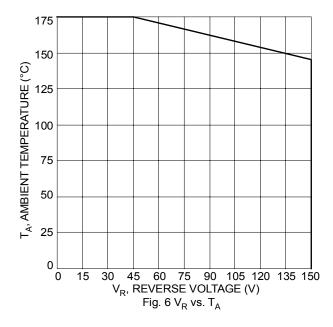
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m V_{R}},$  INSTANTANEOUS REVERSE VOLTAGE (V) Fig. 2 Typical Reverse Characteristics



T<sub>A</sub>, AMBIENT TEMPERATURE (°C) Fig. 4 DC Forward Current Derating







### Ordering Information (Note 6)

Device	Packaging	Shipping
PDS4150-13	PowerDI <sup>®</sup> 5	5000/Tape & Reel

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

# **Marking Information**



S4150 = Product type marking code

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